

MOSFET – Power, Single N-Channel

40 V, 52 A, 7.3 m Ω

NTMYS7D3N04CL

Features

- Small Footprint (5x6 mm) for Compact Design
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Capacitance to Minimize Driver Losses
- LFPAK4 Package, Industry Standard
- These Devices are Pb-Free and are RoHS Compliant

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Symbol	Parameter			Value	Unit
V _{DSS}	Drain-to-Source Voltag	je		40	V
V_{GS}	Gate-to-Source Voltag	е		±20	V
I _D	Continuous Drain Current R _{BJC} (Notes	Steady State	T _C = 25°C	52	Α
	1, 2, 3, 4)	Otate	T _C = 100°C	29	
P_D	Power Dissipation		T _C = 25°C	38	W
	R _{θJC} (Notes 1, 2, 3)		T _C = 100°C	12	
I _D	Continuous Drain	Steady T _A = 25°C		17	Α
	Current R _{θJA} (Notes 1 & 3, 4)	State	T _A = 100°C	12	
P _D	Power Dissipation	T _A = 25°C			W
	R _{θJA} (Notes 1, 3)		T _A = 100°C	1.9	
I _{DM}	Pulsed Drain Current	$T_A = 25$	°C, t _p = 10 μs	269	Α
T _J , T _{stg}	Operating Junction and Storage Temperature			-55 to +175	°C
I _S	Source Current (Body Diode)			31	Α
E _{AS}	Single Pulse Drain-to-Source Avalanche Energy (I _{L(pk)} = 2.9 A)			65	mJ
TL	Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS (Note 1)

Symbol	Parameter	Value	Unit
$R_{\theta JC}$	Junction-to-Case - Steady State (Note 3)		°C/W
$R_{\theta JA}$	Junction-to-Ambient - Steady State (Note 3)		

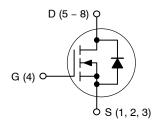
- The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.
- 2. Psi (Ψ) is used as required per JESD51-12 for packages in which substantially less than 100% of the heat flows to single case surface.
- 3. Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.
- Continuous DC current rating. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.

V _{(BR)DSS}	R _{DS(on)} MAX	I _D MAX
40 V	7.3 m Ω @ 10 V	52 A
40 V	12 mΩ @ 4.5 V	32 A

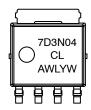


LFPAK4 CASE 760AB

N-Channel



MARKING DIAGRAM



7D3N04CL = Specific Device Code A = Assembly Location

WL = Wafer Lot
 Y = Year
 W = Work Week

ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise noted)

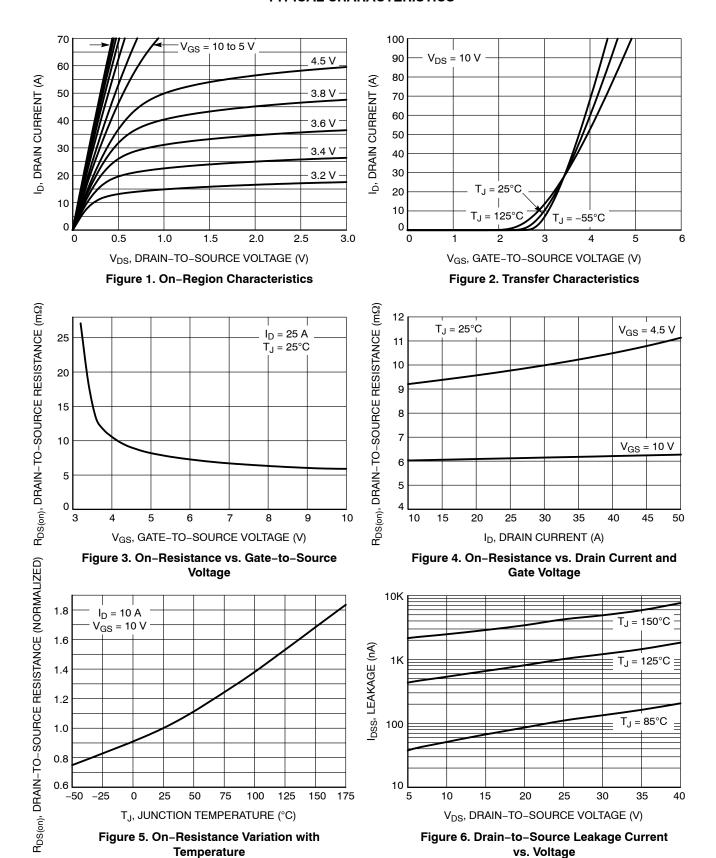
Symbol	Parameter	Test Condition		Min	Тур	Max	Unit
OFF CHARAC	TERISTICS					•	•
V _{(BR)DSS}	Drain-to-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		40			V
V _{(BR)DSS} /	Drain-to-Source Breakdown Voltage Temperature Coefficient				25		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{GS} = 0 V,	$T_J = 25^{\circ}C$			10	μΑ
		V _{DS} = 40 V	T _J = 125°C			250	1
I _{GSS}	Gate-to-Source Leakage Current	$V_{DS} = 0 \text{ V}, V_{G}$	_S = 20 V			100	nA
ON CHARACT	TERISTICS (Note 5)						
V _{GS(TH)}	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_{D}$	= 30 μΑ	1.2		2.0	V
R _{DS(on)}	Drain-to-Source On Resistance	V _{GS} = 10 V, I _I	₀ = 10 A		6.1	7.3	mΩ
		V _{GS} = 4.5 V, I	_D = 10 A		9.7	12	1
9FS	Forward Transconductance	V _{DS} = 15 V, I _E	₀ = 10 A		33		S
CHARGES AN	ID CAPACITANCES		•		•	•	•
C _{iss}	Input Capacitance	V _{GS} = 0 V, f =	1.0 MHz,		860		pF
C _{oss}	Output Capacitance	V _{DS} = 25	5 V		360		1
C _{rss}	Reverse Transfer Capacitance				15		1
Q _{G(TOT)}	Total Gate Charge	V _{GS} = 4.5 V, V _{DS} = 3	32 V, I _D = 10 A		7.0		nC
Q _{G(TH)}	Threshold Gate Charge	V _{GS} = 10 V, V _{DS} = 3	32 V, I _D = 10 A		1.8		nC
Q _{GS}	Gate-to-Source Charge				3.3		1
Q_{GD}	Gate-to-Drain Charge				2.5		1
Q _{G(TOT)}	Total Gate Charge	V _{GS} = 10 V, V _{DS} = 3	32 V, I _D = 10 A		16		nC
SWITCHING	CHARACTERISTICS (Note 6)					•	•
t _{d(on)}	Turn-On Delay Time	V _{GS} = 10 V, V _D			8.0		ns
t _r	Rise Time	$I_D = 10 A, R_C$	$_3$ = 1 Ω		24		1
t _{d(off)}	Turn-Off Delay Time				29		1
t _f	Fall Time				6.0		1
DRAIN-SOUF	ICE DIODE CHARACTERISTICS				•		
V _{SD}	Forward Diode Voltage	$V_{GS} = 0 V$,	$T_J = 25^{\circ}C$		0.84	1.2	V
		I _S = 10 A	T _J = 125°C		0.71		1
t _{RR}	Reverse Recovery Time	$V_{GS} = 0 \text{ V, dI}_S/\text{dt} = 100 \text{ A/}\mu\text{s,}$ $I_S = 10 \text{ A}$			24		ns
ta	Charge Time				11		1
t _b	Discharge Time				12		1
Q _{RR}	Reverse Recovery Charge				11		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

5. Pulse Test: Pulse Width ≤ 300 µs, Duty Cycle ≤ 2%.

^{6.} Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS (continued)

IS, SOURCE CURRENT (A)

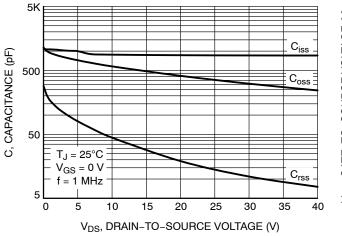


Figure 7. Capacitance Variation

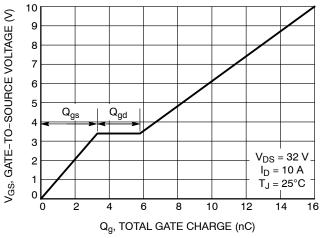


Figure 8. Gate-to-Source vs. Total Charge

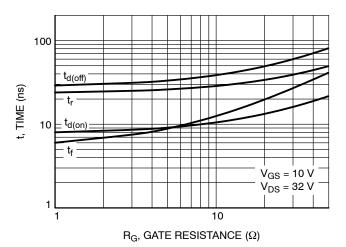


Figure 9. Resistive Switching Time Variation vs. Gate Resistance

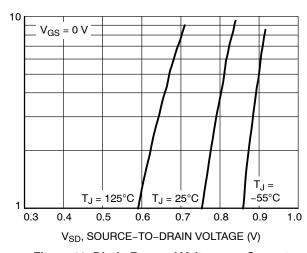


Figure 10. Diode Forward Voltage vs. Current

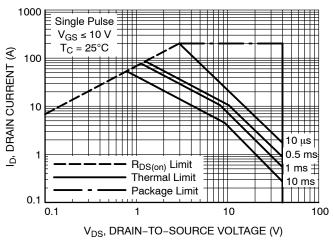


Figure 11. Maximum Rated Forward Biased Safe Operating Area

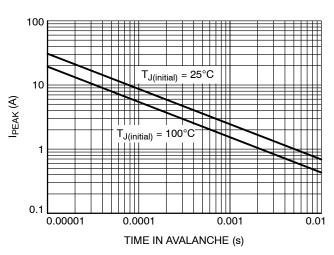


Figure 12. Maximum Drain Current vs. Time in Avalanche

TYPICAL CHARACTERISTICS (continued)

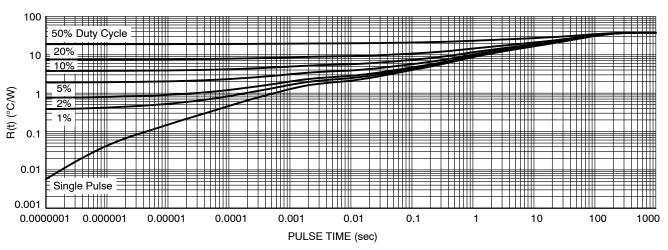


Figure 13. Thermal Characteristics

DEVICE ORDERING INFORMATION

Device	Marking	Package	Shipping [†]
NTMYS7D3N04CLTWG	7D3N04CL	LFPAK4 (Pb-Free)	3,000 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

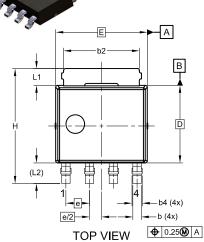


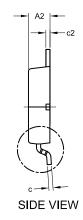
LFPAK4 4.90x4.15x1.15MM, 1.27P CASE 760AB

ISSUE D

1.30

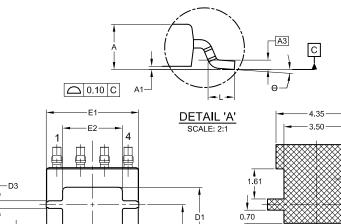
DATE 22 MAY 2024





NOTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2018.
- CONTROLLING DIMENSION: MILLIMETERS.
- 3. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR BURRS. MOLD FLASH PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 0.150mm PER SIDE.
- 4. DIMENSIONS D AND E ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY.



D4

(D8)

-	1.61
1	0.70
	↑
,	1.15
	0.70 - - 1.27 -
	RECOMMENDED LAND PATTERN
	*FOR ADDITIONAL INFORMATION ON OUR
	PB-FREE STRATEGY AND SOLDERING
	I B THEE OH WILLIAM GOLDLINIA

*FOR ADDITIONAL INFORMATION ON OUR PB-FREE STRATEGY AND SOLDERING DETAILS, PLEASE DOWNLOAD THE ONSEMI SOLDERING AND MOUNTING TECHNIQUES REFERENCE MANUAL, SOLDERRM/D.

GENERIC MARKING DIAGRAM*

BOTTOM VIEW

D5

D6 (D7)

XXXXXX XXXXXX AWLYW XXXXXX = Specific Device Code A = Assembly Location

WL = Wafer Lot Y = Year W = Work Week

*This information is generic. Please refer to device data sheet for actual part marking. Some products may not follow the Generic Marking.

DIM MIN NOM MAX A 1.10 1.20 1.30 A1 0.00 0.08 0.15 A2 1.10 1.15 1.20 A3 0.25 BSC 0.50 b 0.40 0.45 0.50 b2 3.80 4.10 4.40 b4 0.45 0.55 0.65 c 0.19 0.22 0.25 c2 0.19 0.22 0.25 D 4.15 BSC 0.20 0.25 D1 3.80 4.00 4.20 D2 3.00 3.10 3.20 D3 0.30 0.40 0.50 D4 0.90 1.00 1.10 D5 0.70 0.80 0.90 D6 0.55 0.65 0.75 D7 0.31 REF D8 0.40 REF E 4.90 BSC E1 4.85 4.95 <td< th=""><th colspan="6">MILLIMETER</th></td<>	MILLIMETER					
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b 0.40 0.45 0.50 b2 3.80 4.10 4.40 b4 0.45 0.55 0.65 c 0.19 0.22 0.25 c2 0.19 0.22 0.25 D 4.15 BSC D1 3.80 4.00 4.20 D2 3.00 3.10 3.20 D3 0.30 0.40 0.50 D4 0.90 1.00 1.10 D5 0.70 0.80 0.90 D6 0.55 0.65 0.75 D7 0.31 REF B8 0.40 REF E 4.90 BSC E1 4.85 4.95 5.05 E2 3.10 3.20 3.30 E3 0.00 0.10 0.20 E4 2.00 2.10 2.20 e 1.27 BSC e/2 0.635 BSC e1 0.40 REF	A2	1.10	1.15	1.20		
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H 6.00 6.15 6.30 L 0.50 0.70 0.90 L1 0.80 0.90 1.00 L2 1.10 REF	e/2					
L 0.50 0.70 0.90 L1 0.80 0.90 1.00 L2 1.10 REF		0.40 REF				
L1 0.80 0.90 1.00 L2 1.10 REF						
L2 1.10 REF	L					
L2 1.10 REF Θ 0° 4° 8°	L1					
Θ 0° 4° 8°		1.10 REF				
	θ	0°	4°	8°		

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